

Electronic Patent Application Fee Transmittal

Application Number:	
Filing Date:	
Title of Invention:	MULTIPLE STACKED DIE WINDOW CSP PACKAGE AND METHOD OF MANUFACTURE
First Named Inventor:	Chuen Khiang WANG
Filer:	Leslie J. Paperner/Ayako Asada
Attorney Docket Number:	P26634

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

National Stage Fee	1631	1	300	300
Natl Stage Search Fee - Report provided	1642	1	400	400
National Stage Exam - all other cases	1633	1	200	200

Pages:

Claims in excess of 20	1615	11	50	550
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Miscellaneous-Filing:

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Petition:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1450